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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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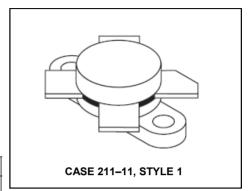


Rev. V1

Designed for power amplifier applications in industrial, commercial and amateur radio equipment to 30 MHz.

- Specified 12.5 V, 30 MHz characteristics
- Output power = 80 W
- Minimum gain = 12 dB
- Efficiency = 50%

Product Image



MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V _{CEO}	25	Vdc
Collector-Base Voltage	V _{CBO}	45	Vdc
Emitter-Base Voltage	V _{EBO}	4.0	Vdc
Collector Current — Continuous	Ic	20	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	250 1.43	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{eJC}	0.7	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

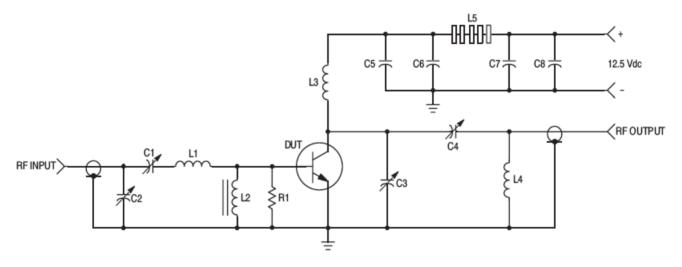
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•			•	
Collector–Emitter Breakdown Voltage (I _C = 100 mAdc, I _B = 0)	V _{(BR)CEO}	18	_	_	Vdc
Collector–Emitter Breakdown Voltage (I _C = 50 mAdc, V _{BE} = 0)	V _{(BR)CES}	36	_	_	Vdc
Emitter–Base Breakdown Voltage (I _E = 10 mAdc, I _C = 0)	V _{(BR)EBO}	4.0	_	_	Vdc
ON CHARACTERISTICS					
DC Current Gain (I _C = 5.0 Adc, V _{CE} = 5.0 Vdc)	h _{FE}	40	_	150	_
DYNAMIC CHARACTERISTICS	•				
Output Capacitance (V _{CB} = 15 Vdc, I _E = 0, f = 1.0 MHz)	C _{ob}	_	_	250	pF



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FUNCTIONAL TESTS (Figure 1)

, ,					
Common–Emitter Amplifier Power Gain (V _{CC} = 12.5 Vdc, P _{out} = 80 W, f = 30 MHz)	G _{pe}	12	_	_	dB
Collector Efficiency (V _{CC} = 12.5 Vdc, P _{out} = 80 W, f = 30 MHz)	η	50	_	_	%
Series Equivalent Input Impedance (V _{CC} = 12.5 Vdc, P _{out} = 80 W, f = 30 MHz)	Z _{in}	_	.938–j.341	_	Ohms
Series Equivalent Output Impedance (V _{CC} = 12.5 Vdc, P _{out} = 80 W, f = 30 MHz)	Z _{out}	_	1.16-j.201	_	Ohms
Parallel Equivalent Input Impedance (V _{CC} = 12.5 Vdc, P _{out} = 80 W, f = 30 MHz)	_	_	1.06 Ω 1817 pF	_	_
Parallel Equivalent Output Impedance (V _{CC} = 12.5 Vdc, P _{out} = 80 W, f = 30 MHz)	_	_	1.19 Ω 777 pF	_	_



C1, C2, C4 - ARCO 469

C3 - ARCO 466

C5 — 1000 pF, UNELCO

C6, C7 — $0.1\,\mu\text{F}$ Disc Ceramic

C8 - 1000 µF/15 V Electrolytic

R1 - 10 Ohm/1.0 Watt, Carbon

L1 - 3 Turns, #18 AWG, 5/16" I.D., 5/16" Long

L2 - VK200-20/4B, FERROXCUBE

L3 — 12 Turns, #18 AWG Enameled Wire, 1/4" I.D., Close Wound

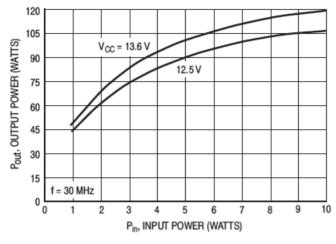
L4 — 3 Turns 1/8" O.D. Copper Tubing, 3/8" I.D., 3/4" Long

L5 — 7 FERRITE Beads, FERROXCUBE #56-590-65/3B

Figure 1. 30 MHz Test Circuit Schematic



Rev. V1



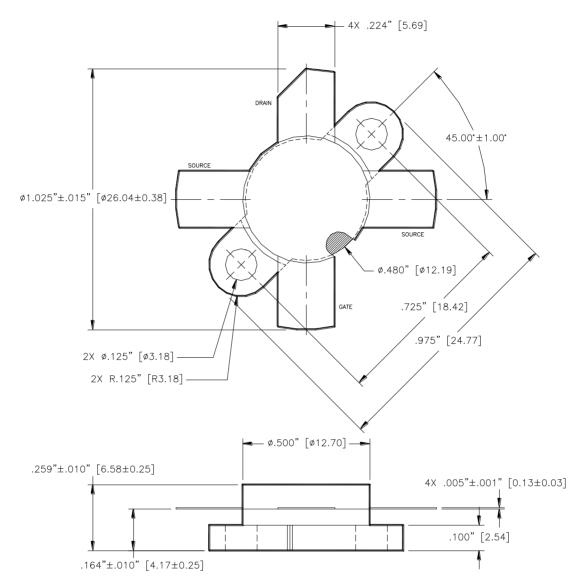
120 105 P_{out}, OUTPUT POWER (WATTS) $P_{in} = 5 V$ 90 3.5 W 75 1.75 W 60 45 30 15 f = 30 MHz 0 10 13 17 V_{CC}, SUPPLY VOLTAGE (VOLTS)

Figure 2. Output Power versus Input Power

Figure 3. Output Power versus Supply Voltage



Rev. V1



Unless otherwise noted, tolerances are inches $\pm .005$ " [millimeters ± 0.13 mm]

MRF454



The RF Line NPN Silicon Power Transistor 80W, 30MHz, 12.5V

Rev. V1

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